

DATA SHEET

BLF277 VHF power MOS transistor

Product specification

September 1992

VHF power MOS transistor

BLF277

FEATURES

- High power gain
- Easy power control
- Gold metallization ensures excellent reliability
- Good thermal stability
- Withstands full load mismatch.

DESCRIPTION

Silicon N-channel enhancement mode vertical D-MOS transistor designed for large signal amplifier applications in the VHF frequency range.

The transistor is encapsulated in a 6-lead, SOT119 flange envelope, with a ceramic cap. All leads are isolated from the flange.

A marking code, showing gate-source voltage (V_{GS}) information is provided for matched pair applications. Refer to the 'General' section for further information.

PINNING - SOT119

PIN	DESCRIPTION
1	source
2	source
3	gate
4	drain
5	source
6	source

PIN CONFIGURATION

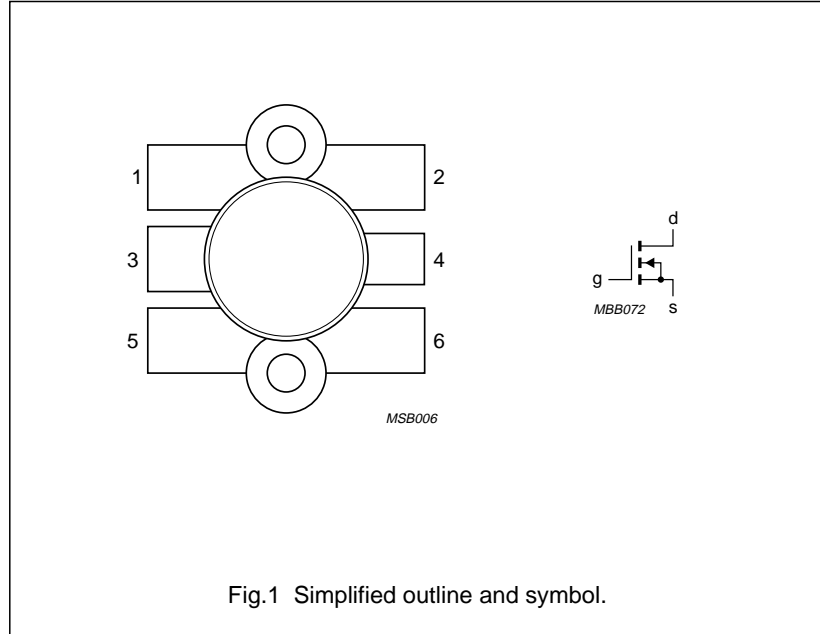


Fig.1 Simplified outline and symbol.

CAUTION

The device is supplied in an antistatic package. The gate-source input must be protected against static charge during transport and handling.

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

QUICK REFERENCE DATA

RF performance at $T_n = 25\text{ °C}$ in a common source circuit.

MODE OF OPERATION	f (MHz)	V_{DS} (V)	P_L (W)	G_p (dB)	η_D (%)
CW, class-B	175	50	150	> 14	> 50

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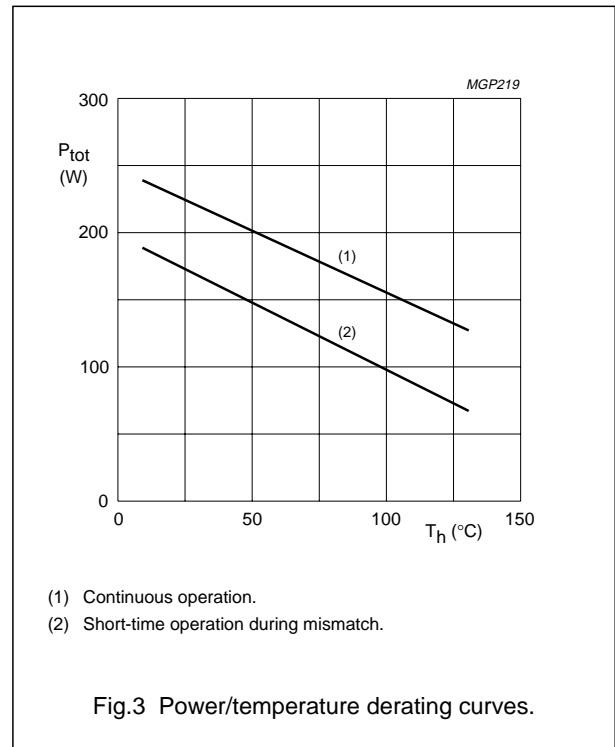
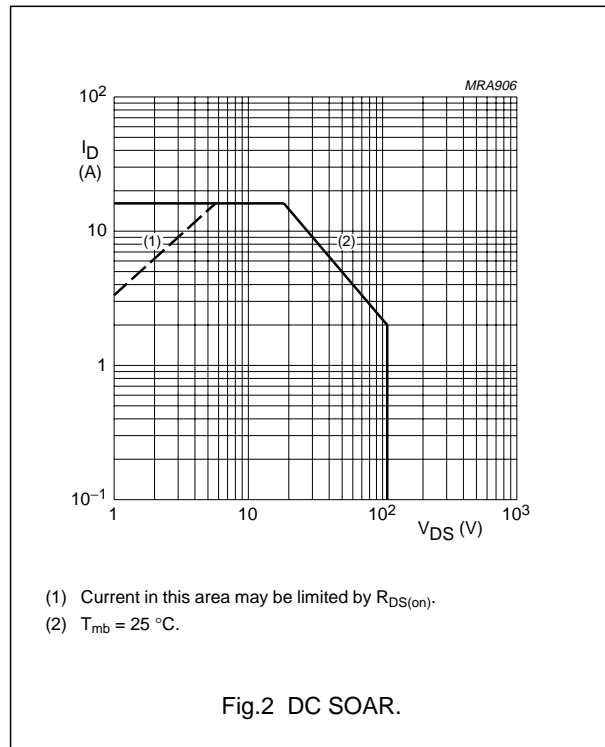
LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	drain-source voltage		–	110	V
$\pm V_{GS}$	gate-source voltage		–	20	V
I_D	DC drain current		–	16	A
P_{tot}	total power dissipation	up to $T_{mb} = 25\text{ }^\circ\text{C}$	–	220	W
T_{stg}	storage temperature		–65	150	$^\circ\text{C}$
T_j	junction temperature		–	200	$^\circ\text{C}$

THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE
$R_{th\ j-mb}$	thermal resistance from junction to mounting base	$T_{mb} = 25\text{ }^\circ\text{C}$; $P_{tot} = 220\text{ W}$	0.8 K/W
$R_{th\ mb-h}$	thermal resistance from mounting base to heatsink	$T_{mb} = 25\text{ }^\circ\text{C}$; $P_{tot} = 220\text{ W}$	0.2 K/W



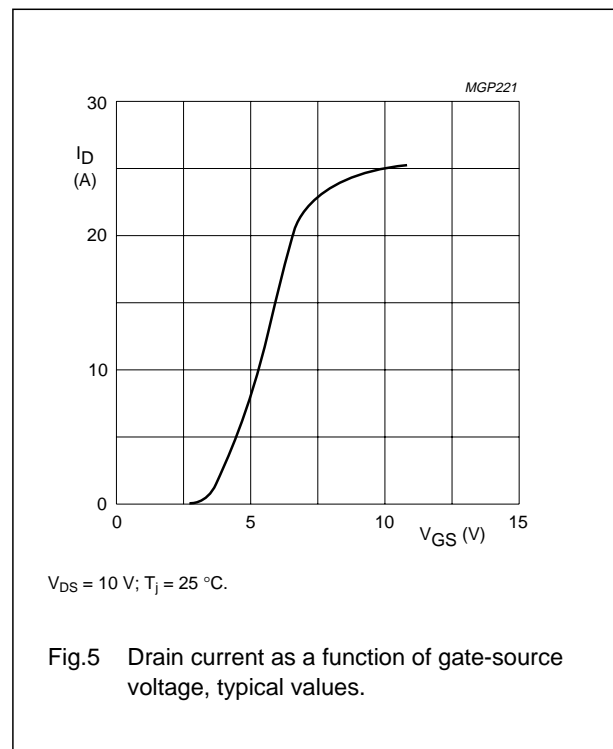
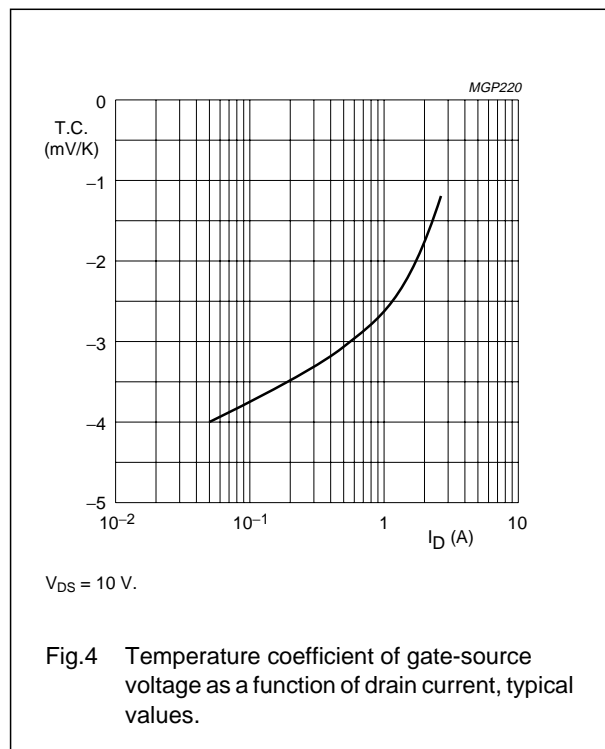
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CHARACTERISTICS

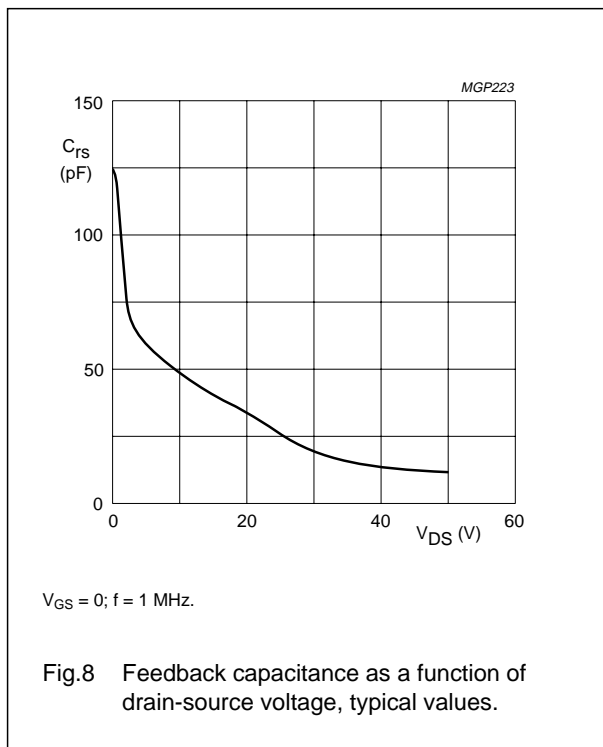
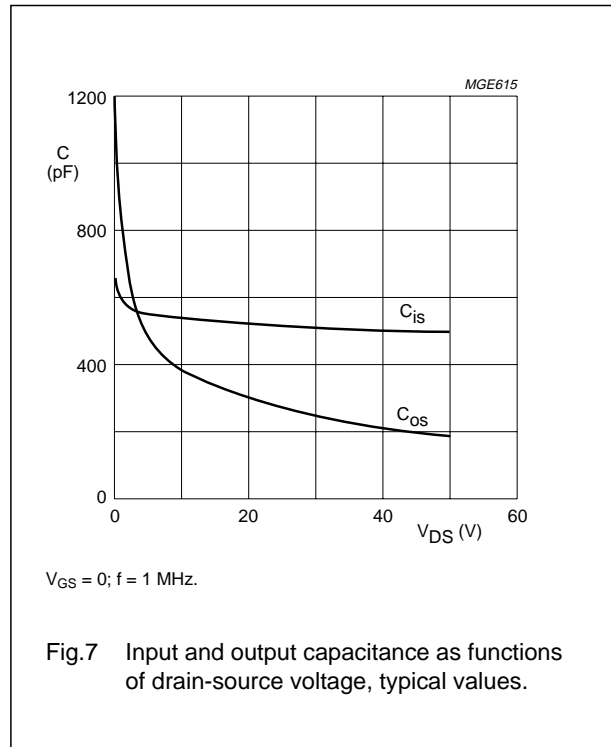
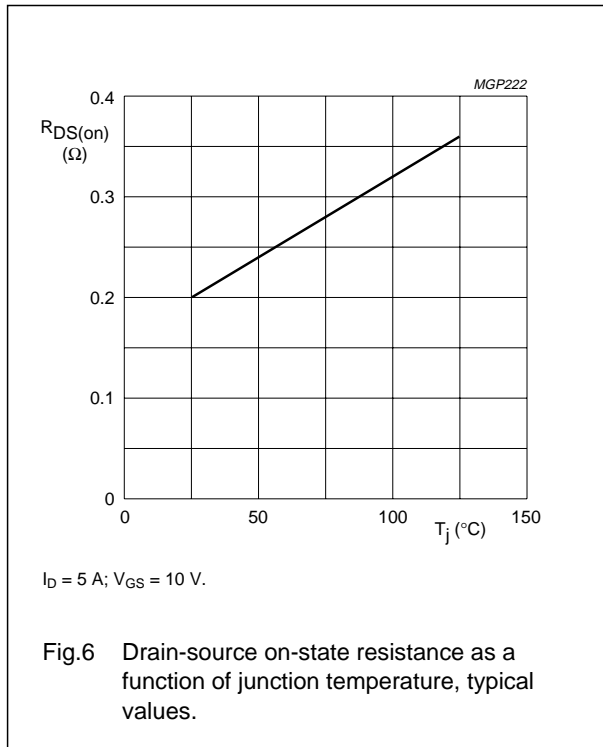
 $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0$; $I_D = 50\text{ mA}$	110	–	–	V
I_{DSS}	drain-source leakage current	$V_{GS} = 0$; $V_{DS} = 50\text{ V}$	–	–	2.5	mA
I_{GSS}	gate-source leakage current	$\pm V_{GS} = 20\text{ V}$; $V_{DS} = 0$	–	–	1	μA
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 50\text{ mA}$; $V_{DS} = 10\text{ V}$	2	–	4.5	V
ΔV_{GS}	gate-source voltage difference of matched pairs	$I_D = 50\text{ mA}$; $V_{DS} = 10\text{ V}$	–	–	100	mV
g_{fs}	forward transconductance	$I_D = 5\text{ A}$; $V_{DS} = 10\text{ V}$	4.5	6.2	–	S
$R_{DS(on)}$	drain-source on-state resistance	$I_D = 5\text{ A}$; $V_{GS} = 10\text{ V}$	–	0.2	0.3	Ω
I_{DSX}	on-state drain current	$V_{GS} = 10\text{ V}$; $V_{DS} = 10\text{ V}$	–	25	–	A
C_{is}	input capacitance	$V_{GS} = 0$; $V_{DS} = 50\text{ V}$; $f = 1\text{ MHz}$	–	480	–	pF
C_{os}	output capacitance	$V_{GS} = 0$; $V_{DS} = 50\text{ V}$; $f = 1\text{ MHz}$	–	190	–	pF
C_{rs}	feedback capacitance	$V_{GS} = 0$; $V_{DS} = 50\text{ V}$; $f = 1\text{ MHz}$	–	14	–	pF



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APPLICATION INFORMATION FOR CLASS-B OPERATION

$T_h = 25\text{ }^\circ\text{C}$; $R_{th,mb-h} = 0.2\text{ K/W}$; $R_{GS} = 16\text{ }\Omega$; unless otherwise specified.

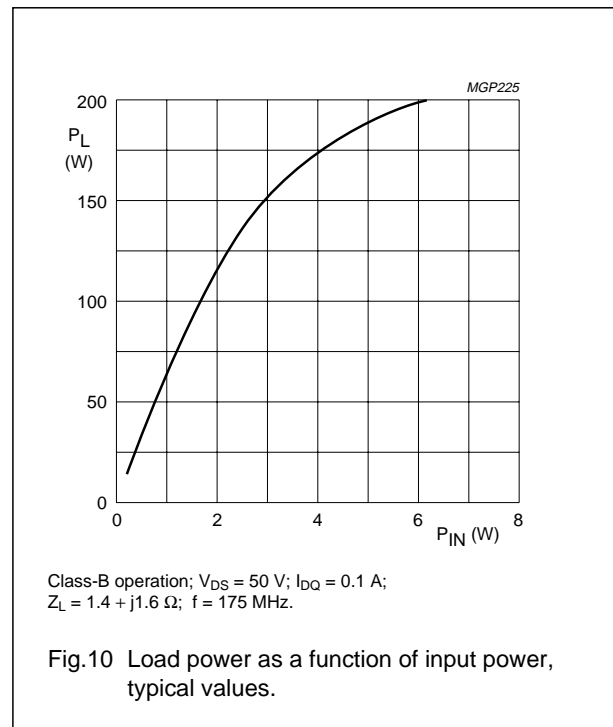
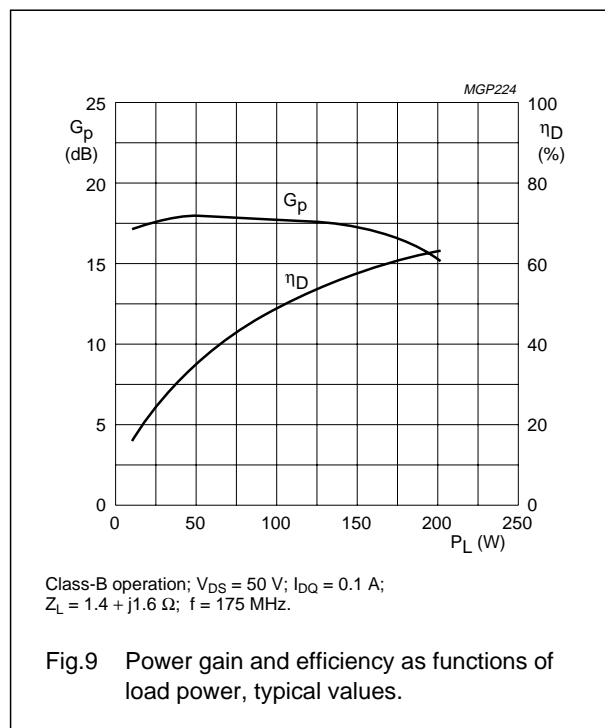
RF performance in CW operation in a common source class-B test circuit.

MODE OF OPERATION	f (MHz)	V_{DS} (V)	I_{DQ} (A)	P_L (W)	G_p (dB)	η_D (%)
CW, class-B	175	50	0.1	150	> 14 typ. 17	> 50 typ. 58

Ruggedness in class-B operation

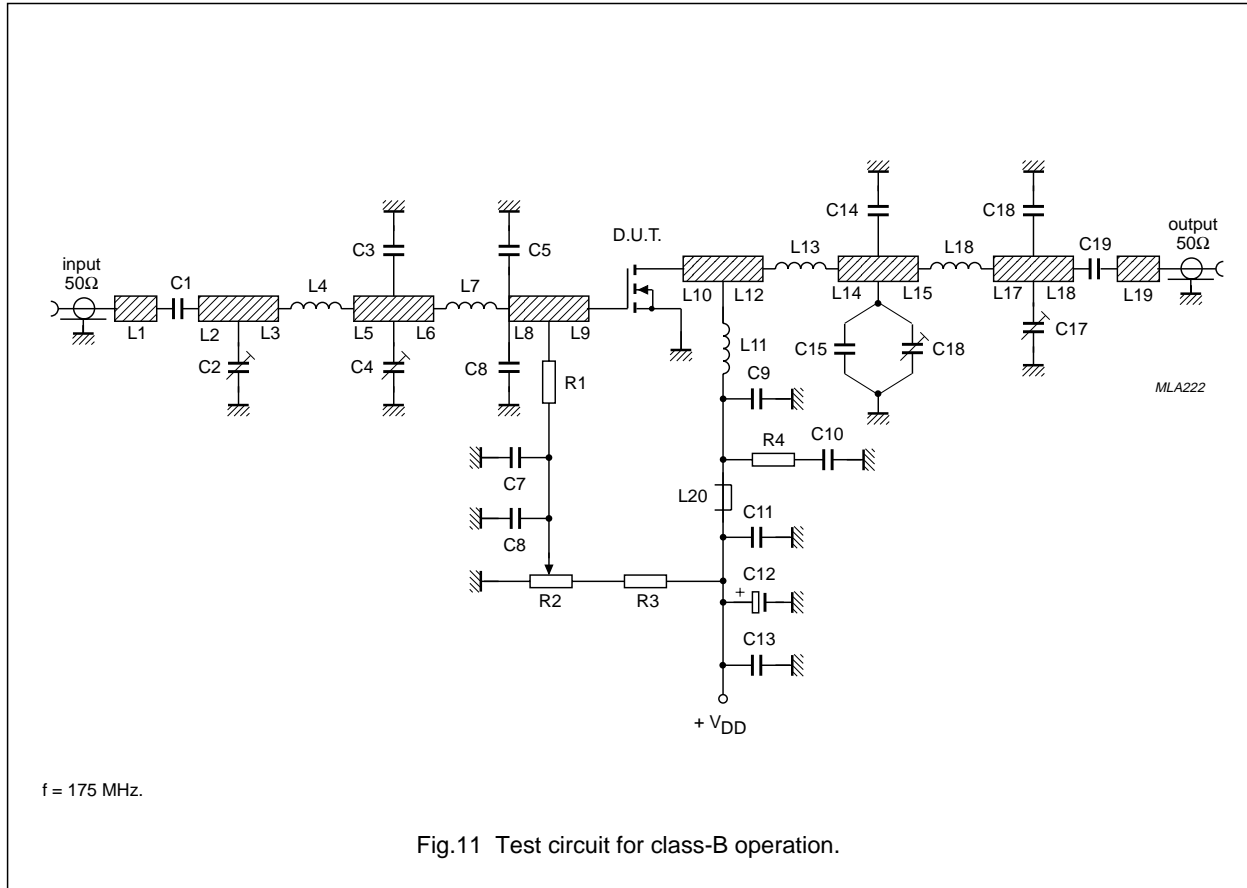
The BLF277 is capable of withstanding a load mismatch corresponding to $VSWR = 50$ through all phases under the following conditions:

$V_{DS} = 50\text{ V}$; $f = 175\text{ MHz}$ at rated load power.



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List of components (class-B test circuit)

COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C8, C19	multilayer ceramic chip capacitor (note 1)	680 pF		
C2, C4, C17	film dielectric trimmer	5 to 60 pF		2222 809 08003
C3	multilayer ceramic chip capacitor (note 1)	33 pF		
C5, C6, C9	multilayer ceramic chip capacitor (note 1)	100 pF		
C7, C10, C13	multilayer ceramic chip capacitor	100 nF		2222 852 47104
C11	multilayer ceramic chip capacitor	10 nF		2222 852 47103
C12	electrolytic capacitor	10 μ F, 63 V		
C14, C15	multilayer ceramic chip capacitor (note 2)	3 \times 22 pF in parallel		
C16	film dielectric trimmer	4 to 40 pF		2222 809 08002
C18	multilayer ceramic chip capacitor (note 1)	18 pF		
L1	stripline (note 3)	49 Ω	length 8 mm width 4 mm	
L2	stripline (note 3)	49 Ω	length 12 mm width 4 mm	
L3	stripline (note 3)	49 Ω	length 7.5 mm width 4 mm	
L4	2 turns enamelled 1.5 mm copper wire	25 nH	length 3.7 mm int. dia. 5 mm leads 2 \times 1 mm	
L5	stripline (note 3)	49 Ω	length 15.5 mm width 4 mm	
L6	stripline (note 3)	49 Ω	length 5 mm width 4 mm	
L7	2 turns enamelled 1.5 mm copper wire	25 nH	length 4.2 mm int. dia. 5 mm leads 2 \times 4 mm	
L8	stripline (note 3)	31 Ω	length 18 mm width 6 mm	
L9	stripline (note 3)	31 Ω	length 6 mm width 6 mm	
L10, L12	stripline (note 3)	31 Ω	length 7 mm width 6 mm	
L11	3 turns enamelled 1.5 mm copper wire	40 nH	length 6.8 mm int. dia. 5 mm leads 2 \times 3 mm	
L13	1 turn enamelled 1.5 mm copper wire	3 nH	int. dia. 2.8 mm leads 2 \times 1 mm	
L14	stripline (note 3)	36 Ω	length 15.5 mm width 5 mm	

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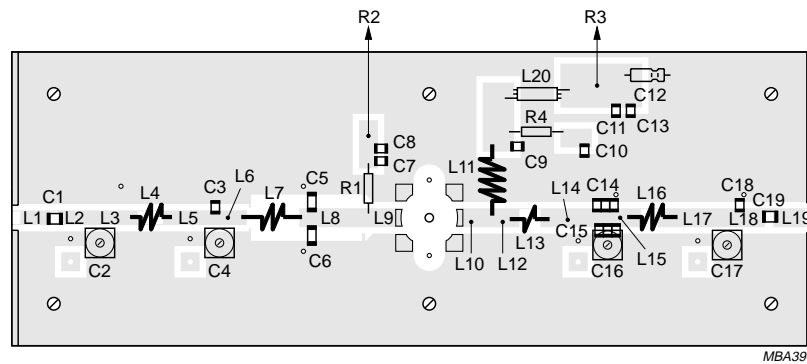
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
L15	stripline (note 3)	36 Ω	length 8 mm width 5 mm	
L16	2 turns enamelled 2.5 mm copper wire	28 nH	length 5.5 mm int. dia. 5 mm leads 2 \times 3 mm	
L17	stripline (note 3)	36 Ω	length 12 mm width 5 mm	
L18, L19	stripline (note 3)	36 Ω	length 8.5 mm width 5 mm	
L20	grade 3B Ferroxcube RF choke			4312 020 36642
R1	0.4 W metal film resistor	16 Ω		
R2	10 turn potentiometer	50 k Ω		
R3	0.4 W metal film resistor	400 k Ω		
R4	0.4 W metal film resistor	100 k Ω		

Notes

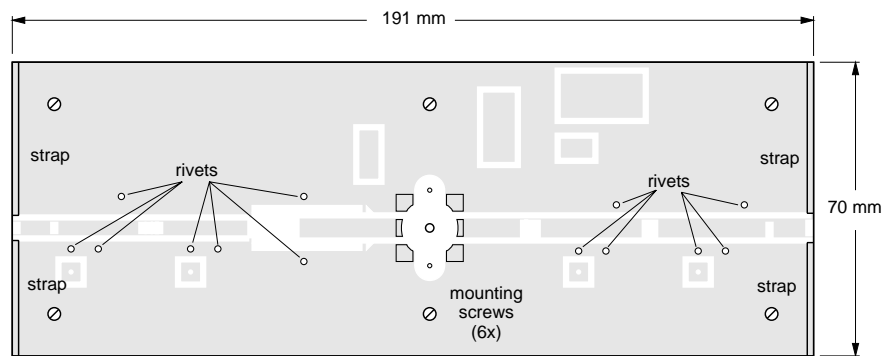
1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
2. American Technical Ceramics (ATC) capacitor, type 175B or other capacitor of the same quality.
3. The striplines are mounted double copper-clad printed circuit board, with epoxy glass dielectric ($\epsilon_r = 4.5$); thickness 1.6 mm.

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MBA394



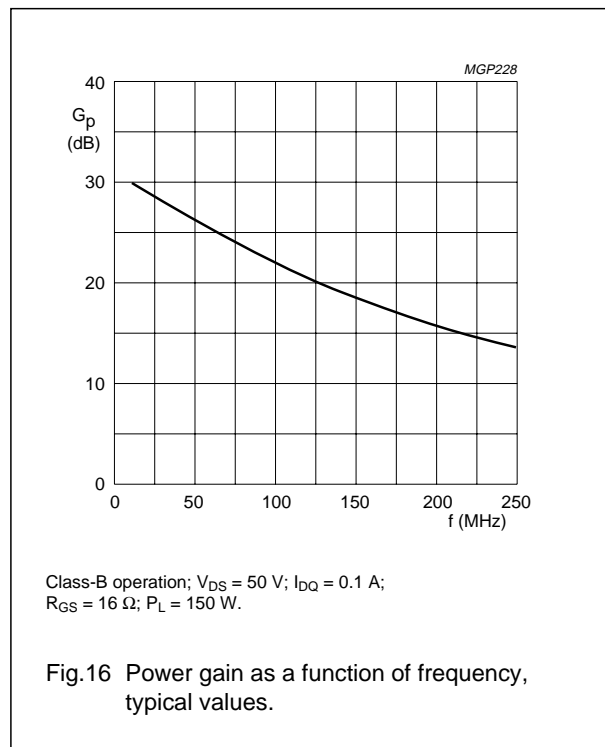
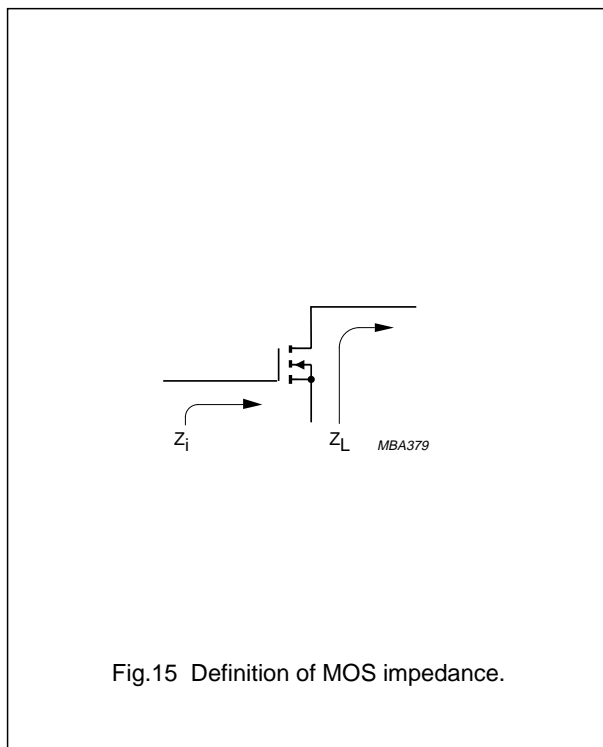
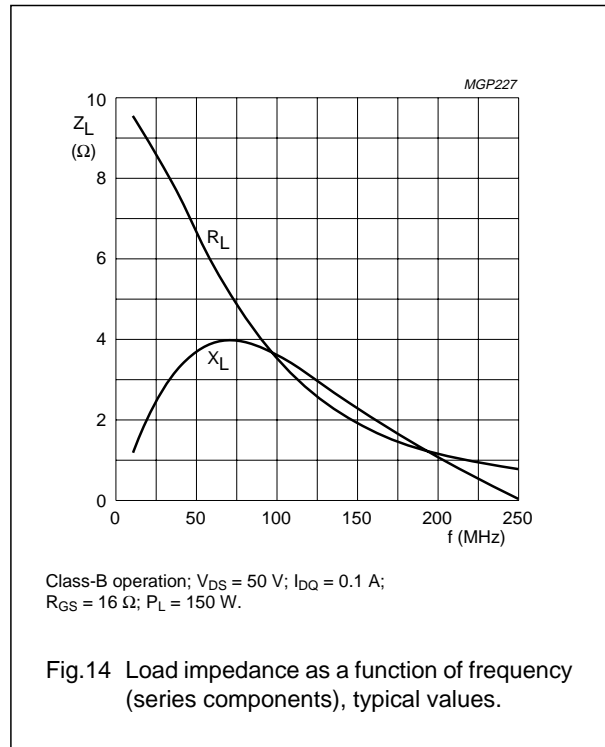
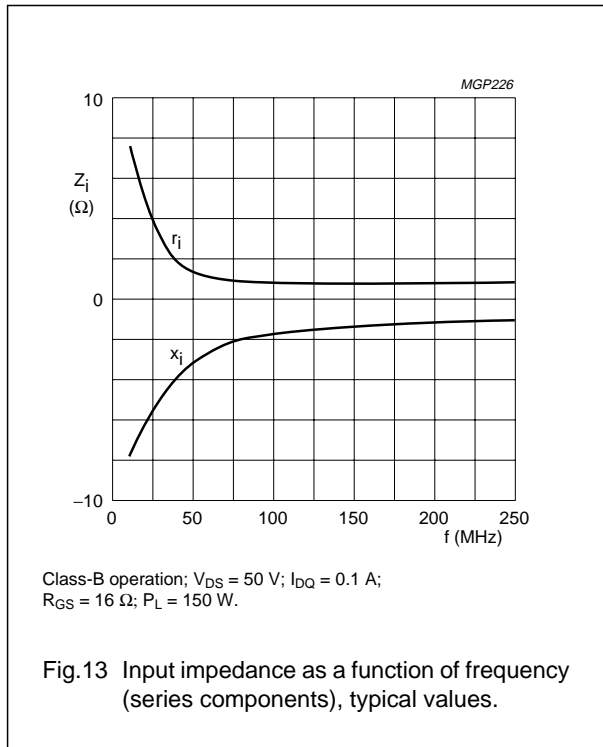
MBA393

The circuit and components are situated on one side of the printed circuit board, the other side being fully metallized, to serve as a ground plane. Earth connections are made by means of copper straps and hollow rivets.

Fig.12 Component layout for 175 MHz class-B test circuit.

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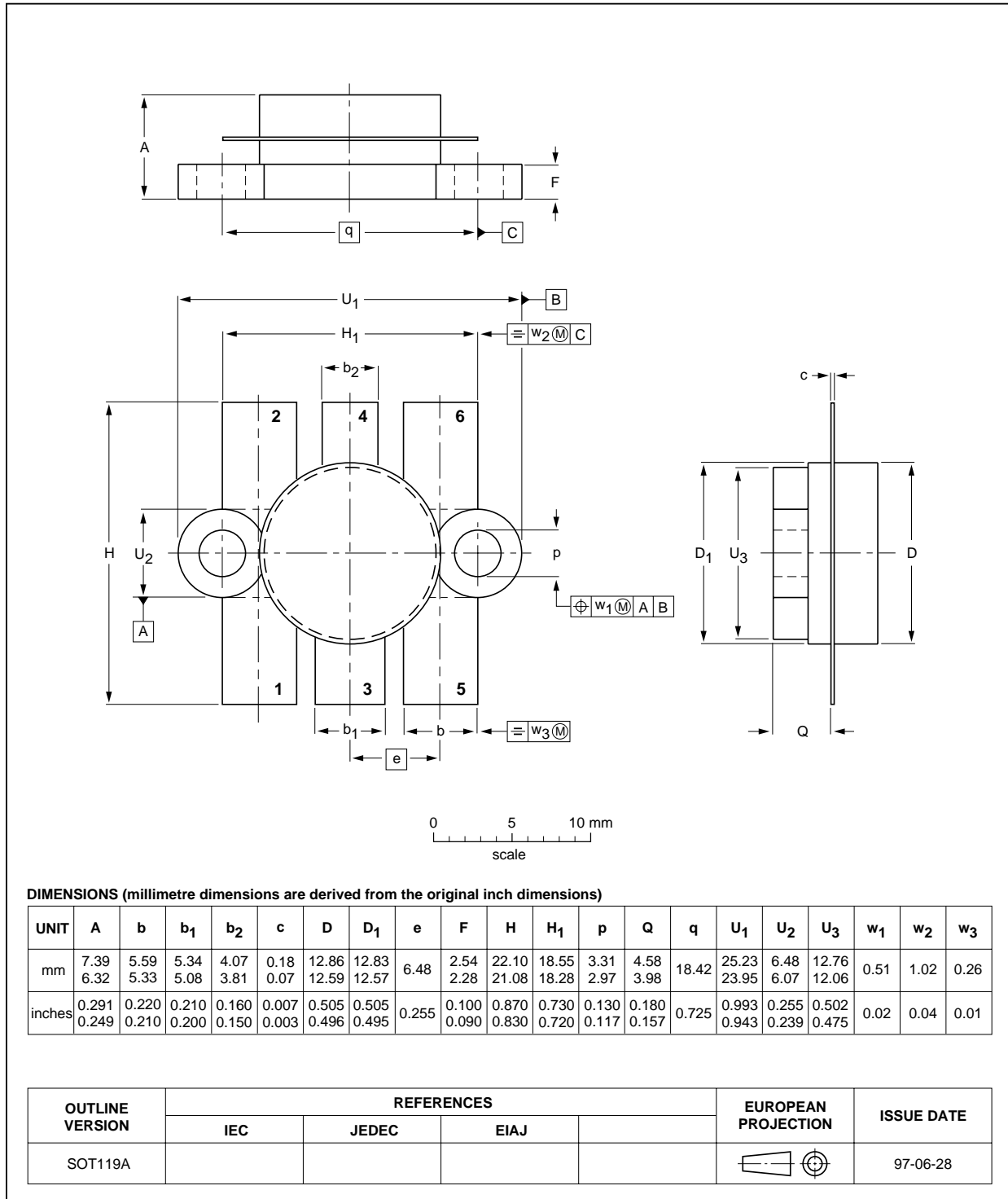
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PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 6 leads

SOT119A



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DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

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